

PRODUCT DATASHEET Rose series

last update 26/2/2015

DETAILS

Product Number FA10666_CXP-D

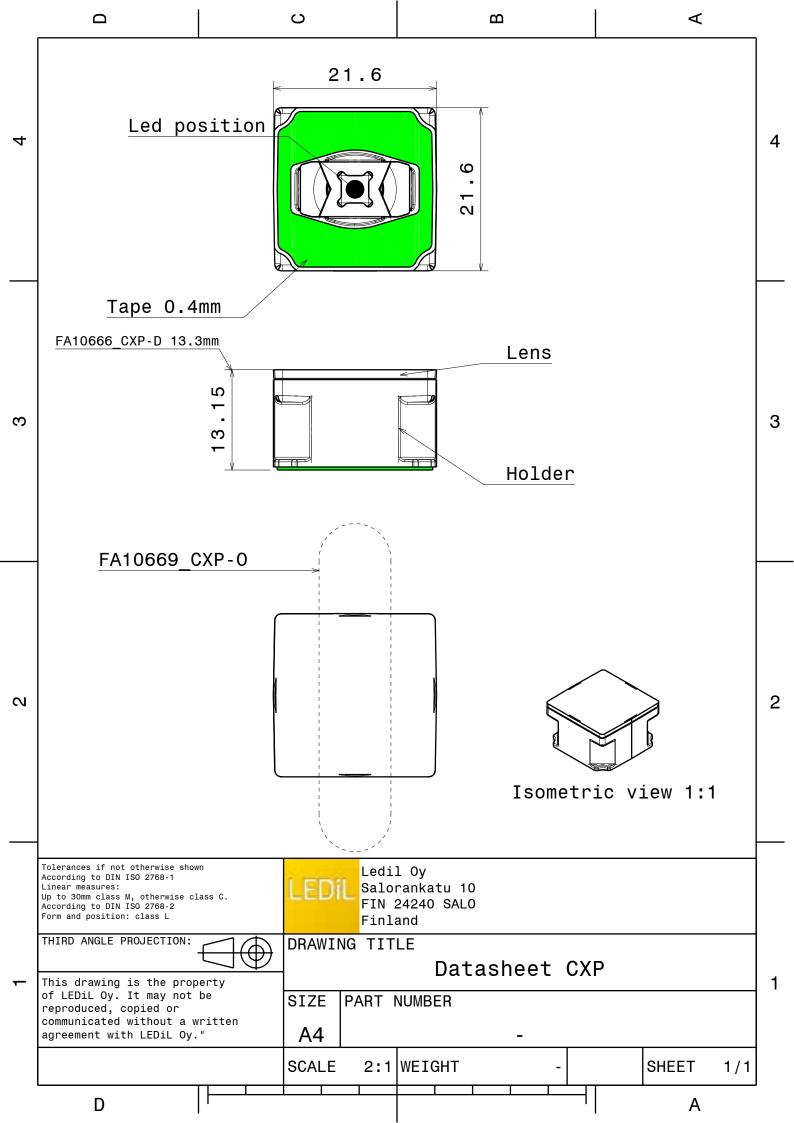
FamilyRoseTypeAssemblyColorblack

Diameter 21,6 + 21,6 mm Height 13.15 mm Style square РС **Optic Material Holder Material** РС Fastening tape Status ready **ROHS Comliant** Yes

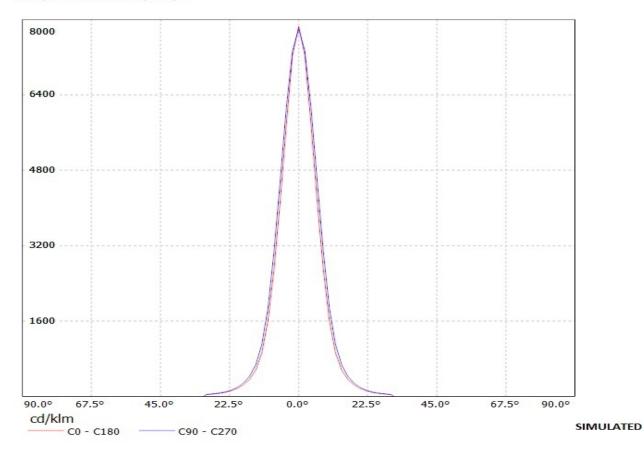
Date Updated 20/03/2015

OPTICAL PROPERTIES

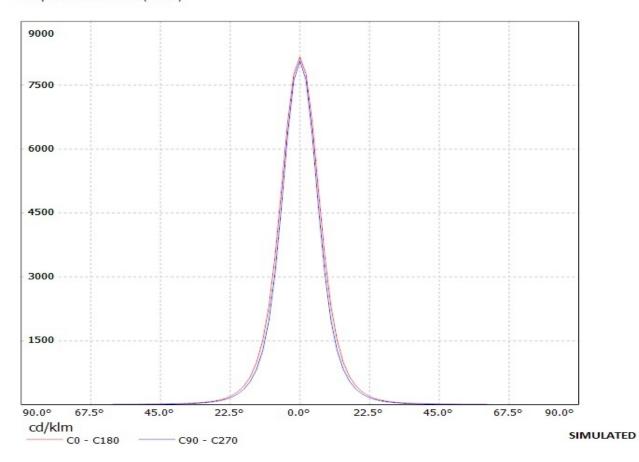
	Viewing	Light	Effi-		
LED	Angle	Beam	ciency	cd/lm	Connector
XP-G2	sim: 15	Diffuser	sim: 86 %	sim: 9.700	-
XP-E-HEW	13 deg	Diffuser	85 %	7.860	-
XP-E	13 deg	Diffuser	85 %	7.860	-
Z5	13 deg	Diffuser	80 %	-	-
XP-G	14 deg	Diffuser	83 %	sim: 0.000	-
XP-L	18 deg	Diffuser	78 %	5.700	-



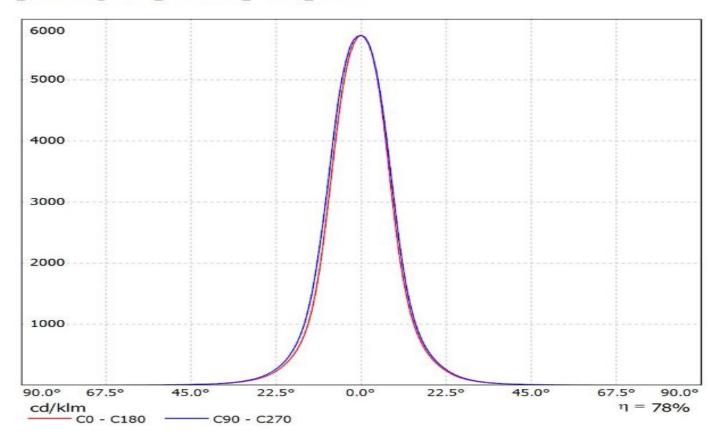
Luminaire: Ledil Oy FA10666_CXP-D FA10666_CXP-D Lamps: 1 x Cree XP-E (white)



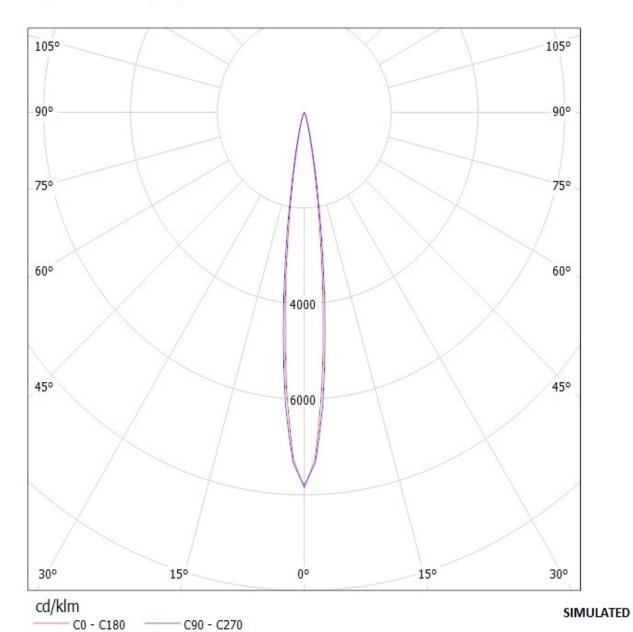
Luminaire: Ledil Oy FA10666_CXP-G-D FA10666_CXP-G-D Lamps: 1 x Cree XP-G (White)



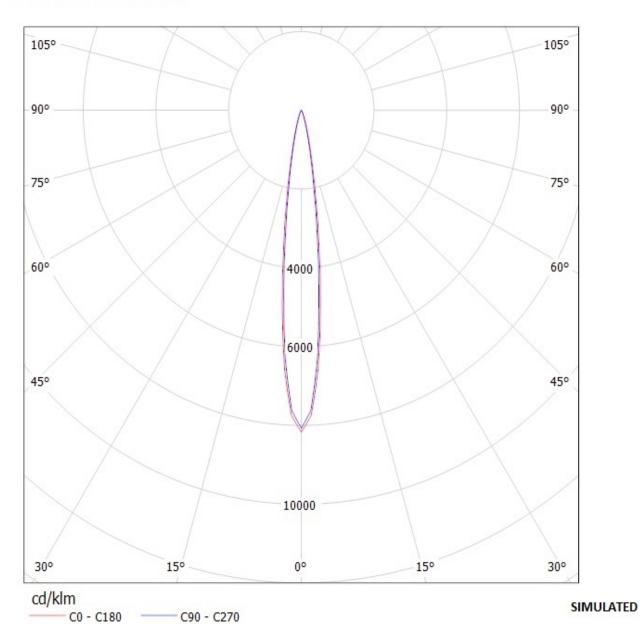
Luminaire: Ledil FA10666_CXP-D_(XP-L)
Lamps: 1 x CREE_XP-L_(XPLAWT-0-7A3-U50-0H-0001)
_107.852lm@250mA_CCT=3185K_P=0.7W_I=0.25A



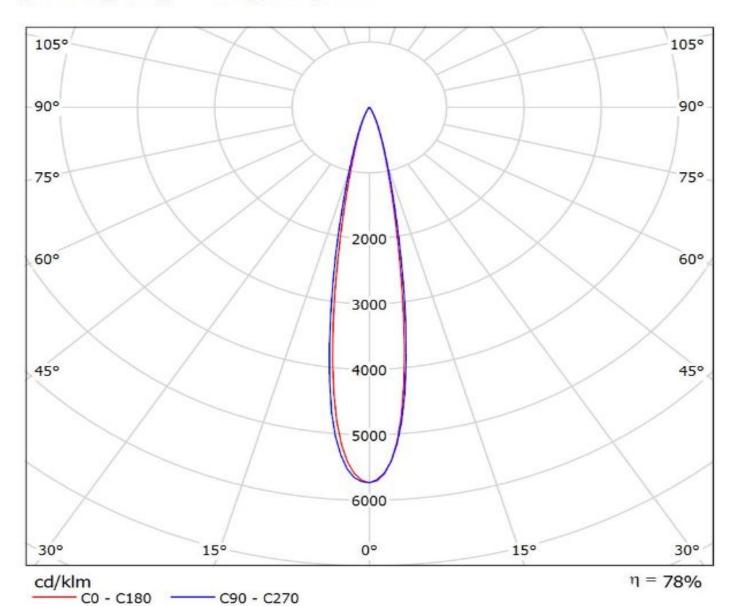
Luminaire: Ledil Oy FA10666_CXP-D FA10666_CXP-D Lamps: 1 x Cree XP-E (white)



Luminaire: Ledil Oy FA10666_CXP-G-D FA10666_CXP-G-D Lamps: 1 x Cree XP-G (White)



Luminaire: Ledil FA10666_CXP-D_(XP-L)
Lamps: 1 x CREE_XP-L_(XPLAWT-0-7A3-U50-0H-0001)
_107.852Im@250mA_CCT=3185K_P=0.7W_I=0.25A



NOTE: The typical divergence will be changed by different color, chip size and chip position tolerance. The typical total divergence is the full angle measured where the luminous intensity is half of the peak value.

GENERAL INFORMATION

- Product series especially designed & optimized for series of LEDs.
- Special care taken to make light distribution as uniform as possible.
- Fastening to heat sink with a PU foam adhesive tape of automotive grade. Please find fastening details by clicking link: http://www.ledil.com/datasheets/DataSheet_TAPE.pdf
- NOTE 1: We advise customer to ensure the suitability and sufficiency of the bond in the end product. For example, mechanical stress, vibration and holes on the surface of the circuit boar weaken the strength of the tape.
- NOTE 2: Assembly to the surface must be made straight, so the tape bonds constant and balanced with fastening surface. Slanted assembly might cause unbalanced bond to the surface. All surfaces where tape is applied must be clean, dry and free from grease and dirt.

If cleaning of PCB surfaces is needed, please follow strictly the cleaning instructions of your LED manufacturer - this is important as cleaning shall under no circumstances damage LEDs or other electronics components on the PCB.

Further note that optical components shall not be cleaned with any chemicals - only micro fiber cloth may be used to remove fingerprints or other traces from handling.